

August 1991

**P-Channel Enhancement-Mode  
Power MOS Field-Effect Transistors**
**Features**

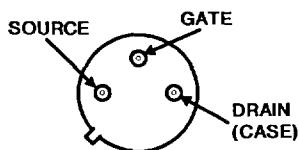
- -1.16A, -100V
- $r_{DS(on)} = 3.65\Omega$
- SOA is Power-Dissipation Limited
- Nanosecond Switching Speeds
- Linear Transfer Characteristics
- High Input Impedance
- Majority Carrier Device

**Description**

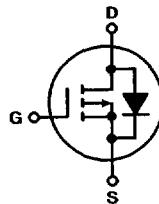
The 2N6895 is a P-channel enhancement-mode silicon-gate power MOS field-effect transistor designed for applications such as switching converters, motor drivers, relay drivers, and drivers for high-power bipolar switching transistors requiring high speed and low gate-drive power. This type can be operated directly from integrated circuits.

The 2N6895 is supplied in the JEDEC TO-205AF metal package.

**Package**

 TO-205AF  
BOTTOM VIEW

**Terminal Diagram**

P-CHANNEL ENHANCEMENT MODE


**Absolute Maximum Ratings ( $T_C = +25^\circ C$ ) Unless Otherwise Specified**

	2N6895	UNITS
Drain-Source Voltage .....	$V_{DSS}$	V
Drain-Gate Voltage ( $R_{GS} = 1M\Omega$ ) .....	$V_{DGR}$	V
Continuous Drain Current		
RMS Continuous .....	$I_D$	A
Pulsed Drain Current .....	$I_{DM}$	A
Gate-Source Voltage .....	$V_{GS}$	V
Maximum Power Dissipation		
$T_C = +25^\circ C$ .....	$P_D$	W
Above $T_C = +25^\circ C$ , Derate Linearly .....	0.0667*	W/ $^\circ C$
Operating and Storage Junction Temperature Range .....	$T_J, T_{STG}$	$^\circ C$
Maximum Lead Temperature for Soldering .....	$T_L$	$^\circ C$
(At distances $\geq \frac{1}{8}''$ (3.17mm) from seating plane for 10s max)	260	

\*JEDEC registered values

## Specifications 2N6895

**ELECTRICAL CHARACTERISTICS** at Case Temperature ( $T_C$ ) = 25°C unless otherwise specified.

CHARACTERISTIC	TEST CONDITIONS	LIMITS		UNITS
		Min.	Max.	
• Drain-Source Breakdown Voltage $BV_{DSS}$	$I_D = 1 \text{ mA}, V_{GS} = 0$	-100	—	V
• Gate Threshold Voltage $V_{GS(\text{th})}$	$V_{GS} = V_{DS}, I_D = 0.25 \text{ mA}$	-2	-4	V
• Zero Gate Voltage Drain Current $I_{DS(0)}$	$V_{DS} = -80 \text{ V}$	—	1	$\mu\text{A}$
	$T_C = 125^\circ\text{C}, V_{DS} = -80 \text{ V}$	—	50	
• Gate-Source Leakage Current $I_{GS}$	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$	—	100	nA
• Drain-Source On Voltage $V_{DS(\text{on})}$ <sup>a</sup>	$I_D = 0.74 \text{ A}, V_{GS} = -10 \text{ V}$	—	2.7	V
	$I_D = 1.16 \text{ A}, V_{GS} = -10 \text{ V}$	—	6	
• Static Drain-Source On Resistance $r_{DS(\text{on})}$ <sup>a</sup>	$I_D = 0.74 \text{ A}, V_{GS} = -10 \text{ V}$	—	3.65	$\Omega$
	$T_C = 125^\circ\text{C}, I_D = 0.74 \text{ A}, V_{GS} = 10 \text{ V}$	—	5.66	
• Forward Transconductance $g_{fS}$ <sup>a</sup>	$V_{DS} = -10 \text{ V}, I_D = 0.74 \text{ A}$	200	800	mho
• Input Capacitance $C_{iss}$	$V_{DS} = -25 \text{ V}$	40	150	
• Output Capacitance $C_{oss}$	$V_{GS} = 0 \text{ V}$	20	80	pF
• Reverse Transfer Capacitance $C_{rss}$	$f = 1 \text{ MHz}$	7.5	30	
• Turn-On Delay Time $t_{d(on)}$	$V_{DS} = -50 \text{ V}$	—	25	
• Rise Time $t_r$	$I_D = 0.74 \text{ A}$	—	45	
• Turn-Off Delay Time $t_{d(off)}$	$R_{gen} = R_{ds} = 15 \Omega$	—	45	
• Fall Time $t_f$	$V_{GS} = -10 \text{ V}$	—	50	
• Thermal Resistance Junction-to-Case $R_{\thetaJC}$		—	15	°C/W

### SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

CHARACTERISTIC	TEST CONDITIONS	LIMITS		UNITS
		Min.	Max.	
• Diode Forward Voltage $V_{SD}$ <sup>a</sup>	$I_{SD} = 1.16 \text{ A}$	0.8	1.6	V
• Reverse Recovery Time $t_{rr}$	$I_F = 4 \text{ A}, dI_F/dt = 50 \text{ A}/\mu\text{s}$	—	340	ns

\*In accordance with JEDEC registration data.

<sup>a</sup>Pulsed: Pulse duration = 300  $\mu\text{s}$  max., duty cycle = 2%

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P-CHANNEL  
POWER MOSFETs

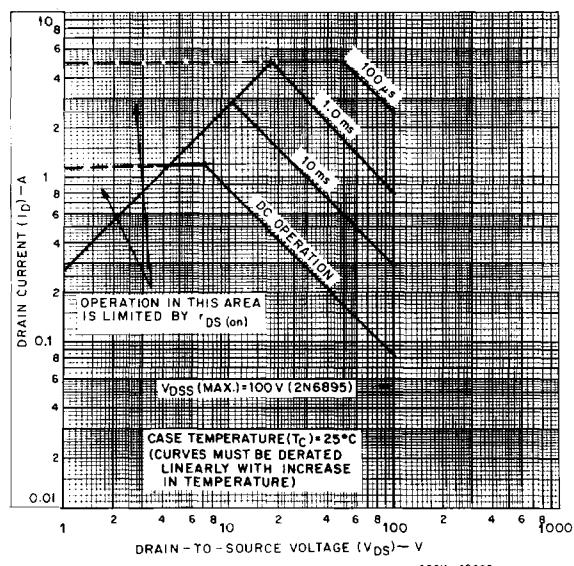


Fig. 1 - Maximum operating areas.

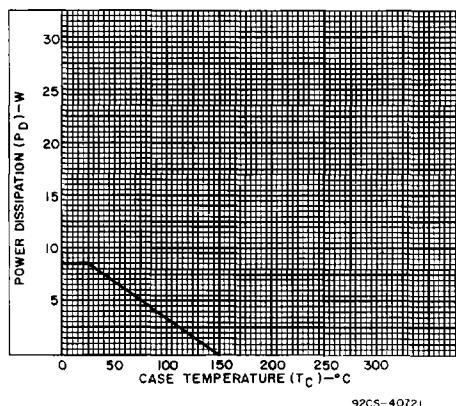


Fig. 2 - Power dissipation vs. temperature derating curve.

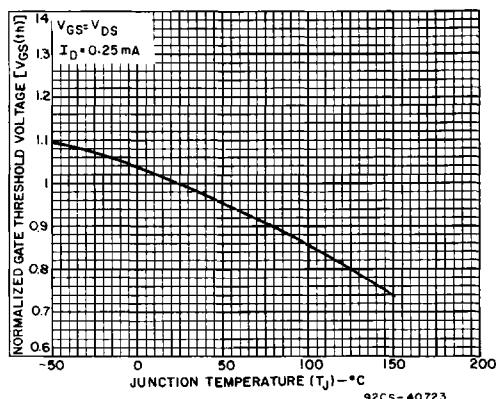


Fig. 3 - Typical normalized gate threshold voltage as a function of junction temperature.

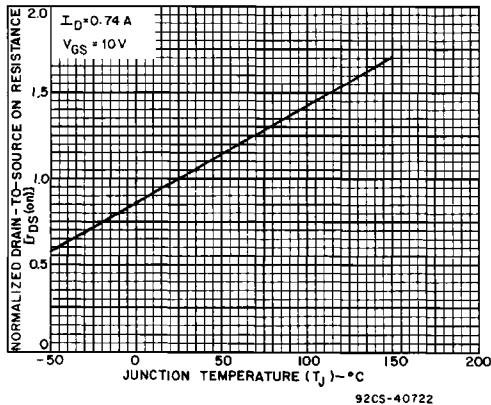


Fig. 4 - Typical normalized drain-to-source on resistance to junction temperature.

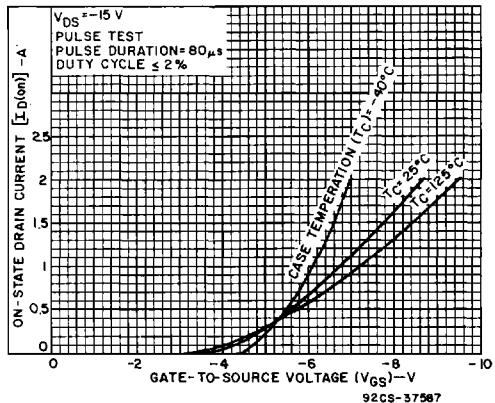


Fig. 5 - Typical transfer characteristics.

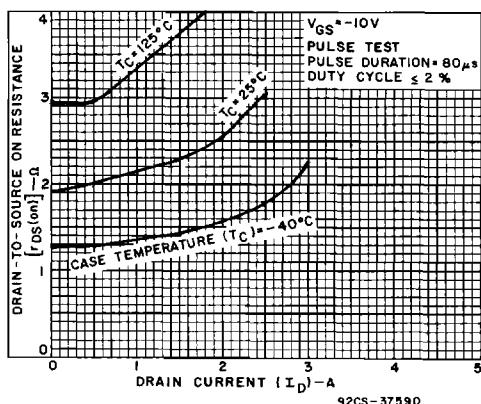


Fig. 6 - Typical drain-to-source on resistance as a function of drain current.

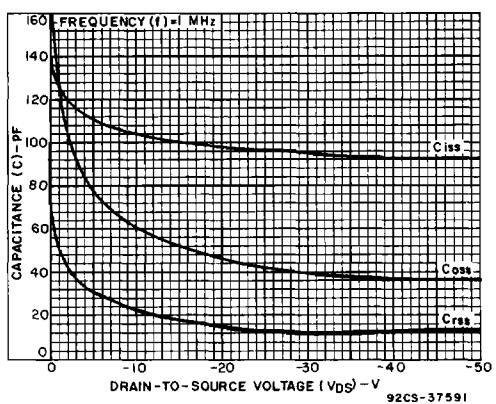


Fig. 7 - Capacitance as a function of drain-to-source voltage.

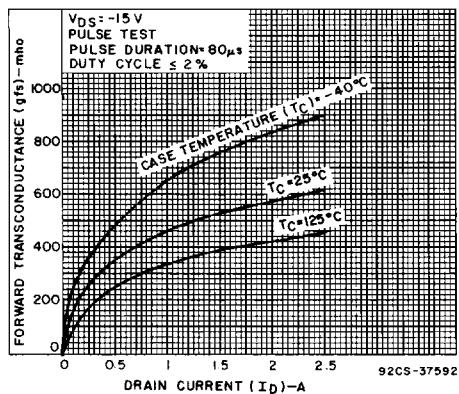


Fig. 8 - Typical forward transconductance as a function of drain current.